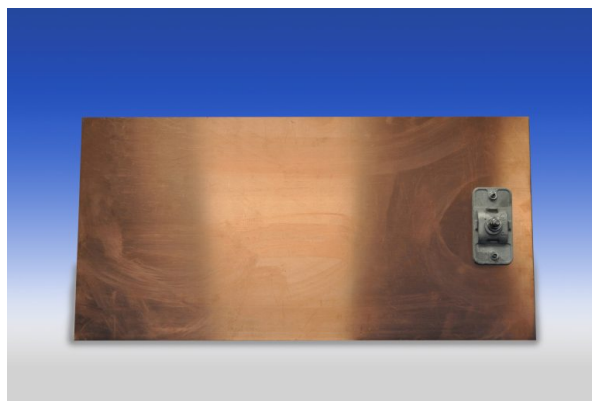


GROUNDING PLATES - COPPER GP-12XX



APPLICATION:

Designed to enhance ground grid systems in compliance with UL 96 and NFPA 780 standards. The copper ground plate is a 0.032" thick, high-conductivity copper sheet featuring a UL 96-listed bonding plate. Custom sizes are available upon request.

NOTE:

- NFPA 780 4.13.6.1: A ground plate electrode must have a minimum thickness of 0.032" and a minimum surface area of 2 square feet.
- NFPA 780 4.13.6.2: The ground plate electrode must be buried no less than 18 inches below grade.

AVAILABLE:

GP-1212: 12" x 12" copper grounding plate, 0.032" thickness

GP-1224: 12" x 24" copper grounding plate, 0.032" thickness

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